



FEATURES

- Low profile package
- Ideal for automated placement
- Glass passivated pellet chip junction
- Low reverse current
- Low forward voltage
- Soft recovery characteristic
- Ultra fast reverse recovery time
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- AEC-Q101 qualified available
 - Automotive ordering code: base P/NHE3 or P/NHM3

TYPICAL APPLICATIONS

For use in high frequency rectification and freewheeling application in switching mode converters and inverters for consumer, computer, automotive, and telecommunication.

MECHANICAL DATA

Case: SMA (DO-214AC)

Molding compound meets UL 94 V-0 flammability rating

Base P/N-E3 - RoHS-compliant, commercial grade

Base P/N-M3 - halogen-free, RoHS-compliant, and commercial grade

Base P/NHE3_X - RoHS-compliant and AEC-Q101 qualified

Base P/NHM3_X - halogen-free, RoHS-compliant, and AEC-Q101 qualified

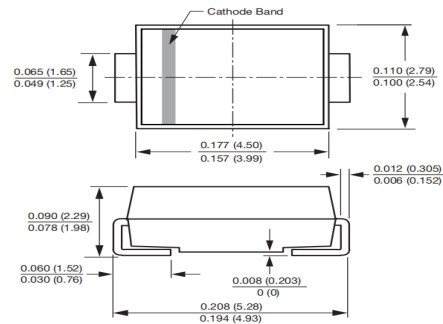
("_X" denotes revision code e.g. A, B,...)

Terminals: Matte tin plated leads, solderable per J-STD-002 and JESD 22-B102

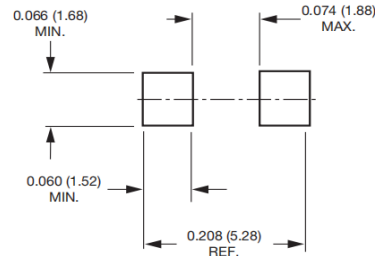
E3, M3, HE3, and HM3 suffix meet JESD 201 class 2 whisker test

Polarity: Color band denotes the cathode end

SMA (DO-214AC)



Mounting Pad Layout



PRIMARY CHARACTERISTICS	
$I_{F(AV)}$	2.0 A
V_{RRM}	50 V, 100 V, 200 V
I_{FSM}	35 A
I_R	1.0 μ A
V_F at I_F	1.1 V
t_{rr}	25 ns
E_R	20 mJ
T_J max.	150 °C
Package	SMA (DO-214AC)
Diode variations	Single

MAXIMUM RATINGS ($T_A = 25$ °C unless otherwise noted)					
PARAMETER	SYMBOL	BYG22A	BYG22B	BYG22D	UNIT
Device marking code		BYG22A	BYG22B	BYG22D	
Maximum repetitive peak reverse voltage	V_{RRM}	50	100	200	V
Average forward current	$I_{F(AV)}$	2.0			A
Peak forward surge current 10 ms single half sine-wave superimposed on rated load	I_{FSM}	35			A
Pulse energy in avalanche mode, non repetitive (inductive load switch off) $I_{(BR)} = 1$ A, $T_J = 25$ °C	E_R	20			mJ
Operating junction and storage temperature range	T_J, T_{STG}	-55 to +150			°C



ELECTRICAL CHARACTERISTICS ($T_A = 25\text{ }^\circ\text{C}$ unless otherwise noted)							
PARAMETER	TEST CONDITIONS		SYMBOL	BYG22A	BYG22B	BYG22D	UNIT
Maximum instantaneous forward voltage	$I_F = 1.0\text{ A}$	$T_J = 25\text{ }^\circ\text{C}$	$V_F^{(1)}$	1.0			V
	$I_F = 2.0\text{ A}$			1.1			
Maximum reverse current	$V_R = V_{RRM}$	$T_J = 25\text{ }^\circ\text{C}$	I_R	1			μA
		$T_J = 100\text{ }^\circ\text{C}$		10			
Maximum reverse recovery time	$I_F = 0.5\text{ A}, I_R = 1.0\text{ A}, I_{rr} = 0.25\text{ A}$		t_{rr}	25			ns

Note

(1) Pulse test: 300 μs pulse width, 1 % duty cycle

THERMAL CHARACTERISTICS ($T_A = 25\text{ }^\circ\text{C}$ unless otherwise noted)						
PARAMETER	SYMBOL	BYG22A	BYG22B	BYG22D	UNIT	
Maximum thermal resistance, junction to lead, $T_L = \text{const.}$	$R_{\theta JL}$	25			$^\circ\text{C/W}$	
Maximum thermal resistance, junction to ambient	$R_{\theta JA}^{(1)}$	150			$^\circ\text{C/W}$	
	$R_{\theta JA}^{(2)}$	125				
	$R_{\theta JA}^{(3)}$	100				

Notes

- (1) Mounted on epoxy-glass hard tissue
- (2) Mounted on epoxy-glass hard tissue, 50 mm² 35 μm Cu
- (3) Mounted on Al-oxide-ceramic (Al_2O_3), 50 mm² 35 μm Cu

ORDERING INFORMATION (Example)				
PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE
BYG22D-E3/TR	0.064	TR	1800	7" diameter plastic tape and reel
BYG22D-E3/TR3	0.064	TR3	7500	13" diameter plastic tape and reel
BYG22DHE3_A/H ⁽¹⁾	0.064	H	1800	7" diameter plastic tape and reel
BYG22DHE3_A/I ⁽¹⁾	0.064	I	7500	13" diameter plastic tape and reel
BYG22D-M3/TR	0.064	TR	1800	7" diameter plastic tape and reel
BYG22D-M3/TR3	0.064	TR3	7500	13" diameter plastic tape and reel
BYG22DHM3_A/H ⁽¹⁾	0.064	H	1800	7" diameter plastic tape and reel
BYG22DHM3_A/I ⁽¹⁾	0.064	I	7500	13" diameter plastic tape and reel

Note

(1) AEC-Q101 qualified



RATINGS AND CHARACTERISTICS CURVES ($T_A = 25\text{ }^\circ\text{C}$ unless otherwise noted)

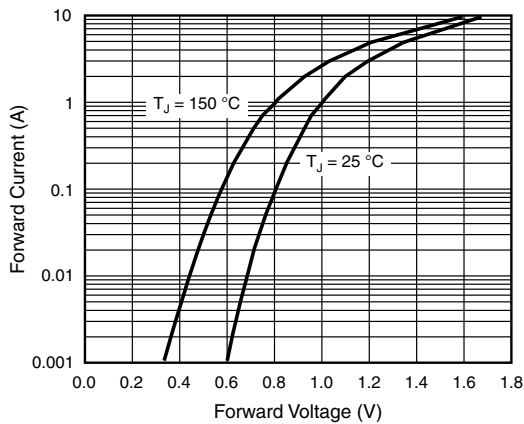


Fig. 1 - Forward Current vs. Forward Voltage

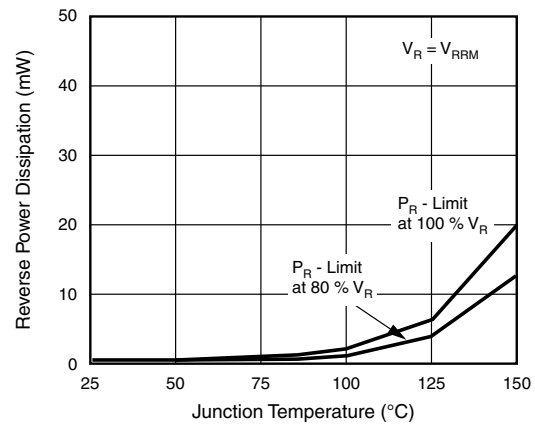


Fig. 4 - Max. Reverse Power Dissipation vs. Junction Temperature

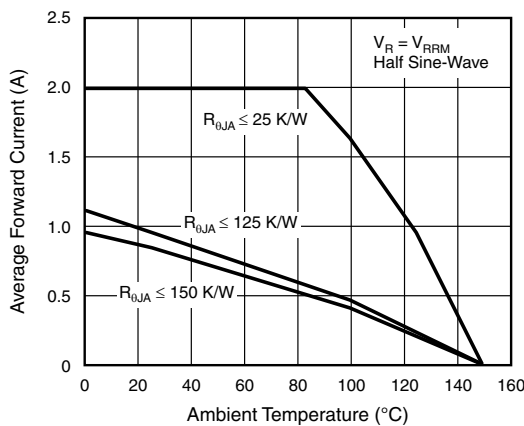


Fig. 2 - Max. Average Forward Current vs. Ambient Temperature

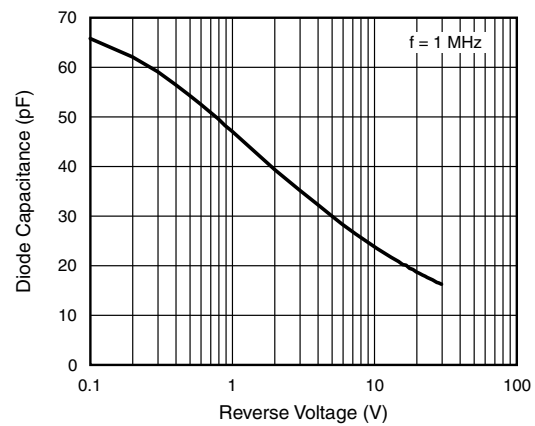


Fig. 5 - Diode Capacitance vs. Reverse Voltage

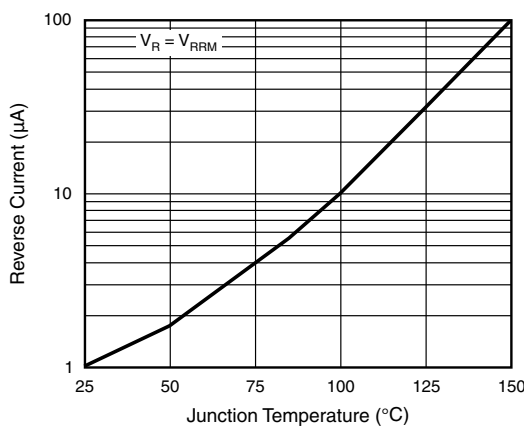


Fig. 3 - Reverse Current vs. Junction Temperature

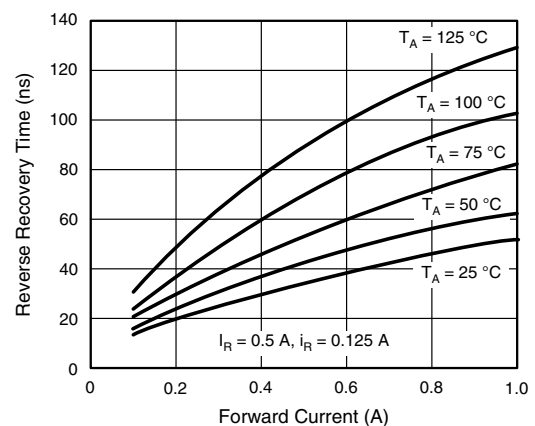


Fig. 6 - Max. Reverse Recovery Time vs. Forward Current

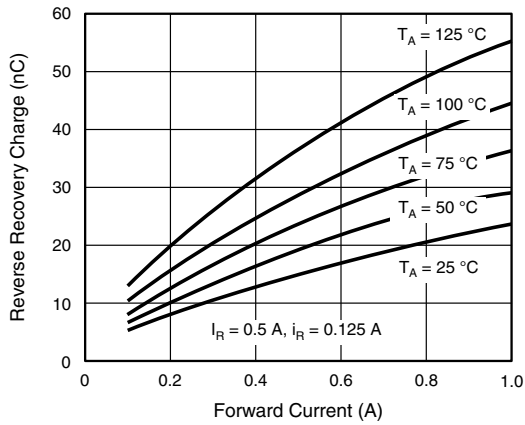


Fig. 7 - Max. Reverse Recovery Charge vs. Forward Current

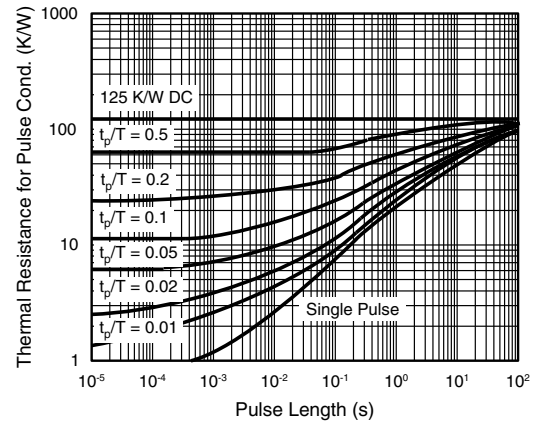


Fig. 8 - Thermal Response